

RoHS

# **Power Operational Amplifiers**

### **FEATURES**

- High Internal Dissipation 400W
- High Current 40A Continuous, 80A Peak
- High Slew Rate 50V/μs
- Optional Boost Voltage Inputs

#### **APPLICATIONS**

- Semi-conductor Testing
- Brushless DC Motor Drive
- Voltage Controlled Current Source
- Electromagnetic Driver

## DESCRIPTION



The PA52 is a MOSFET power operational amplifier that extends the performance limits of power amplifiers in slew rate and power bandwidth, while maintaining high current and power dissipation ratings. Boost voltage inputs allow the small signal portion of the amplifier to operate at a higher voltage than the high current output stage. The amplifier is then biased to achieve close linear swings to the supply rails at high currents for extra efficient operation.

The JEDEC MO-127 12-pin Power Dip<sup>™</sup> package (see Package Outlines) is hermetically sealed and isolated from the internal circuits. The use of compressible thermal washers and/or improper mounting torque will void the product warranty. Please see Application Note 1, "General Operating Considerations".



## **TYPICAL CONNECTION**

### Figure 1: Typical Connection





## PINOUT AND DESCRIPTION TABLE



Pin Number	Name	Description
1	-IN	The inverting input.
2	+IN	The non-inverting input.
3, 4	-Vs	The negative supply rail. Pins 3 and 4 are internally connected.
5, 6	-OUT	The negative output. Pins 5 and 6 are not internally connected. Short pins 5, 6, 7, and 8.
7, 8	+OUT	The positive output. Pins 7 and 8 are not internally connected. Short pins 5, 6, 7, and 8.
9, 10	+Vs	The positive supply rail. Pins 9 and 10 are internally connected.
11	+VB	The positive boost supply rail. Short to +Vs if unused. See applicable section.
12	-VB	The negative boost supply rail. Short to -Vs if unused. See applicable section.

#### **Figure 2: External Connections**



## **SPECIFICATIONS**

Unless otherwise noted:  $T_C = 25$ °C, DC input specifications are ± value given. Power supply voltage is typical rating.  $\pm V_{BOOST} = \pm V_S$ .

#### ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Units
Supply Voltage, +V <sub>s</sub> To -V <sub>s</sub>	+V <sub>s</sub> to -V <sub>s</sub>		200	V
Boost Voltage, +V <sub>B</sub> To -V <sub>B</sub>			230	V
Output Current, within SOA	۱ <sub>0</sub>		80	А
Power Dissipation, internal	P <sub>D</sub>		400	W
Input Voltage, differential	V <sub>IN (Diff)</sub>	-20	20	V
Input Voltage, common mode	V <sub>cm</sub>	-V <sub>B</sub>	+V <sub>B</sub>	V
Temperature, pin solder, 10s			350	°C
Temperature, junction <sup>1</sup>	Tj		150	°C
Temperature, storage		-65	+150	°C
Operating Temperature Range, case	Т <sub>С</sub>	-55	+125	°C

1. Long term operation at the maximum junction temperature will result in reduced product life. Derate internal power dissipation to achieve high MTTF. For guidance, refer to the heatsink data sheet.



The PA52 is constructed from MOSFET transistors. ESD handling procedures must be observed. The internal substrate contains beryllia (BeO). Do not break the seal. If accidentally broken, do not crush, machine, or subject to temperatures in excess of 850°C to avoid generating toxic fumes.



#### INPUT

Parameter	Test	PA52				Units		
Tarameter	Conditions	Min	Тур	Max	Min	Тур	Max	Units
Offset Voltage, initial			5	10		2	5	mV
Offset Voltage vs. temperature	Full temp range		20	50		*	*	μV/°C
Offset Voltage vs. supply			10	30		*	*	μV/V
Bias Current, initial			10	50		*	*	pА
Bias Current vs. supply			0.01			*		pA/V
Offset Current, initial			10	50		*	*	pА
Input Impedance, DC			10 <sup>11</sup>			*		Ω
Input Capacitance			13			*		pF
Common Mode Voltage Range	Full temp range	-V <sub>B</sub> +12 +V <sub>B</sub> -14			*			V
Common Mode Rejection, DC	Full temp range, V <sub>CM</sub> = ±20V	90	100			*	*	dB
Input Noise	100 kHz BW, Rs=1 kΩ		10			*		μVrms

#### GAIN

Parameter	Test	PA52			PA52A			Units
Falameter	Conditions	Min	Тур	Max	Min	Тур	Max	Onits
Open Loop, @ 15 Hz	Full temp range	94	102		*	*		dB
Gain Bandwidth Product	R <sub>L</sub> =10 Ω		3			*		MHz
Power Bandwidth	$R_L = 4 \Omega,$ $V_o=180V_{P-P},$ $A_V= -10$ Full temp range		90			*		kHz



#### OUTPUT

Parameter	Test	PA52			PA52A			Unito
Faidilletei	Conditions	Min	Тур	Max	Min	Тур	Max	Units
Voltage Swing	I <sub>o</sub> = 40A	±V <sub>S</sub> ±9.5	$\pm V_{S} \pm 8.0$		*	*		V
Voltage Swing, PA52	$\pm V_B = \pm V_S \pm 10V,$ $I_0 = 40A$	±V <sub>S</sub> ±5.8	±V <sub>S</sub> ±4.0					V
Voltage Swing, PA52A	$\pm V_B = \pm V_S \pm 10V,$ $I_0 = 50A$				±V <sub>S</sub> ±5.8	±V <sub>S</sub> ±5.0		V
Current, peak	3ms 10% Duty Cycle	80			*			А
Settling Time to 0.1%	A <sub>V</sub> = -10, 10V Step, R <sub>L</sub> =4 Ω		1			*		μs
Slew Rate	A <sub>V</sub> =-10	50			*			V/µs
Resistance	I <sub>O</sub> =0, No Load, 2 MHz		2.5			*		Ω

#### **POWER SUPPLY**

Parameter	Test	PA52				Units		
Falameter	Conditions	Min	Тур	Max	Min	Тур	Max	Units
Voltage, ±V <sub>B</sub>	Full temp range	+14,-12	±30	±115	*	*	*	V
Voltage, ±V <sub>S</sub>	Full temp range	±3		±110	*		*	V
Current, quiescent, boost supply			26	32		*	*	mA
Current, quiescent, total			30	36		*	*	mA

#### THERMAL

Parameter	Test	PA52			PA52A			Units
Falameter	Conditions	Min	Тур	Max	Min	Тур	Max	Onits
Resistance, AC, junction to case <sup>1</sup>	Full temp range, F > 60 Hz		0.2	0.25		*	*	°C/W
Resistance, DC, junction to case	Full temp range, F > 60 Hz		0.25	0.31		*	*	°C/W
Resistance, junction to air	Full temp range		12			*		°C/W
Temperature Range, case	Meets full range specification	-25		85	*		*	°C

1. Rating applies if the output current alternates between both output transistors at a rate faster than 60 Hz.

Note: \*The specification of PA52A is identical to the specification for PA52 in applicable column to the left



### **TYPICAL PERFORMANCE GRAPHS**



**Figure 4: Power Supply Rejection** 



Figure 7: Output Voltage Swing

**Figure 9: Power Response** 





Figure 8:



Figure 11: Quiescent Current





### **SAFE OPERATING AREA (SOA)**

Figure 12: SOA



#### **GENERAL**

Please read Application Note 1 "General Operating Considerations" which covers stability, supplies, heat sinking, mounting, current limit, SOA interpretation, and specification interpretation. Visit www.apexanalog.com for Apex Microtechnology's complete Application Notes library, Technical Seminar Workbook, and Evaluation Kits.

#### **CURRENT LIMIT**

There is no internal circuit provision for current limit in the PA52. However, the PA52 circuit board in the PA52 evaluation kit does provide a means whereby the output current can be sensed. An external circuit current limit can thereby be implemented if needed.

#### **BOOST OPERATION**

With the V<sub>BOOST</sub> feature the small signal stages of the amplifier are operated at higher supply voltages than the amplifier's high current output stage. +V<sub>BOOST</sub> (pin 11) and  $-V_{BOOST}$  (pin 12) are connected to the small signal circuitry of the amplifier. +V<sub>S</sub> (pin 9,10) and  $-V_S$  (pin 3,4) are connected to the high current output stage. An additional 10V on the V<sub>BOOST</sub> pins is sufficient to allow the small signal stages to drive the out-



put transistors into saturation and improve the output voltage swing for extra efficient operation when required. When close swings to the supply rails is not required the  $+V_{BOOST}$  and  $+V_{S}$  pins must be strapped together as well as the  $-V_{BOOST}$  and  $-V_{S}$  pins. The boost voltage pins must not be at a voltage lower than the  $V_{S}$  pins.

## **COMPENSATION**

Compensation is internally fixed for a gain of 3 or more and is not adjustable by the user. The PA52 therefore is not unity gain stable.

#### **POWER SUPPLY BYPASSING**

Proper and sufficient power supply bypassing is crucial to proper operation of the PA52. Bypass the +Vb and -Vb supply pins with a minimum  $0.1\mu$ F ceramic capacitors directly at the supply pins. On the +Vs and -Vs pins use a combination of ceramic and electrolytic capacitors. Use  $1\mu$ F ceramic capacitors and an electrolytic capacitor at least  $10\mu$ F for each amp of output current required.

### NEED TECHNICAL HELP? CONTACT APEX SUPPORT!

For all Apex Microtechnology product questions and inquiries, call toll free 800-546-2739 in North America. For inquiries via email, please contact apex.support@apexanalog.com. International customers can also request support by contacting their local Apex Microtechnology Sales Representative. To find the one nearest to you, go to www.apexanalog.com

#### IMPORTANT NOTICE

Apex Microtechnology, Inc. has made every effort to insure the accuracy of the content contained in this document. However, the information is subject to change without notice and is provided "AS IS" without warranty of any kind (expressed or implied). Apex Microtechnology reserves the right to make changes without further notice to any specifications or products mentioned herein to improve reliability. This document is the property of Apex Microtechnology and by furnishing this information, Apex Microtechnology grants no license, expressed or implied under any patents, mask work rights, copyrights, trademarks, trade secrets or other intellectual property rights. Apex Microtechnology owns the copyrights associated with the information contained herein and gives consent for copies to be made of the information only for use within your organization with respect to Apex Microtechnology integrated circuits or other products of Apex Microtechnology. This consent does not extend to other copying such as copying for general distribution, advertising or promotional purposes, or for creating any work for resale.

APEX MICROTECHNOLOGY PRODUCTS ARE NOT DESIGNED, AUTHORIZED OR WARRANTED TO BE SUITABLE FOR USE IN PRODUCTS USED FOR LIFE SUPPORT, AUTOMOTIVE SAFETY, SECURITY DEVICES, OR OTHER CRITICAL APPLICATIONS. PRODUCTS IN SUCH APPLICATIONS ARE UNDERSTOOD TO BE FULLY AT THE CUSTOMER OR THE CUSTOMER'S RISK.

Apex Microtechnology, Apex and Apex Precision Power are trademarks of Apex Microtechnology, Inc. All other corporate names noted herein may be trademarks of their respective holders.





### **PACKAGE DESIGN**

#### PACKAGE STYLE CR





#### NOTES:

- Dimensions are in inches & [mm]. Triangle on lid and notch in header denote pin 1. Header material: Nickel-plated CRS Lid material: Solid nickel Pin material: Solderable nickel-plated Alloy 52 Welded hermetic package seal Isolation: 1000 VDC any pin to case Package weight: 1.87 oz [53 g]
- 1. 2. 3. 4. 5.

- 6. 7. 8.